

MRPC3b for CBM TOF

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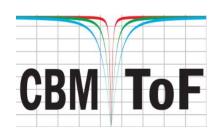
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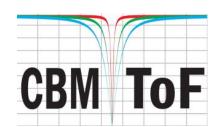
Outline



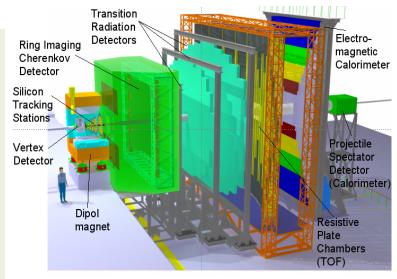
- > Introduction
- ➤ MRPC3b——design and characteristics
- Production: Quality Control & Assurance
- > Status and time line
- > Summary

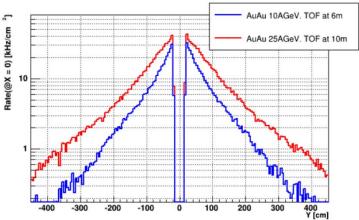


MRPC TOF for CBM



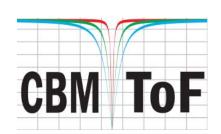
- CBM: a future (2024) fix target heavy ion collision experiment at FAIR in Germany.
- MRPC TOF is the key PID system for CBM.
- Special requirements:
- ➤ Large area: ~ 120 m²
- High rate: 0.1-100 kHz/cm²
- Free streaming DAQ: Triggerless



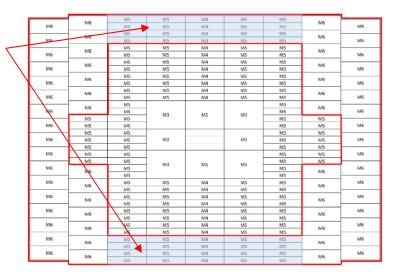




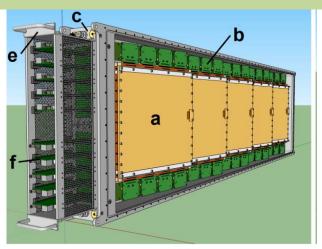
MRPC3b on CBM TOF wall



- MRPC3b: for the low rate region of CBM TOF
- Rate requirement: <1 kHz/cm²
- Thin float glass as electrodes
- 200 MRPC3b needed for CBM TOF



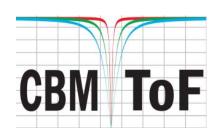
5 MRPC3b in one CBM module



MRPC notation	MRPC1	MRPC2	MRPC3a	MRPC3b	MRPC4
Number of MRPCs	40	246	580	200	310
Active area [mm ²]	300×100	300×200	320×270	320×270	320×530
Number of Strips per MRPC	72	72	32	32	32
Strip length [mm]	100	200	270	270	530
Granularity (cell size) [mm ²]	416.7	833.3	2700	2700	5300
Number of gas gaps	10	10	8	8	8
Gap size μ m	140	140	220	220	220
Glass size [mm ²]	320×100	320×200	330×280	330×280	330×540
Glass thickness [mm]	0.7	0.7	0.7	0.5	0.5
Number of glass plates	12	12	9	9	9
Glass type	low res.	low res.	low res.	float	float
Total glass surface [m ²]	15.36	188.93	482.33	166.32	497.18

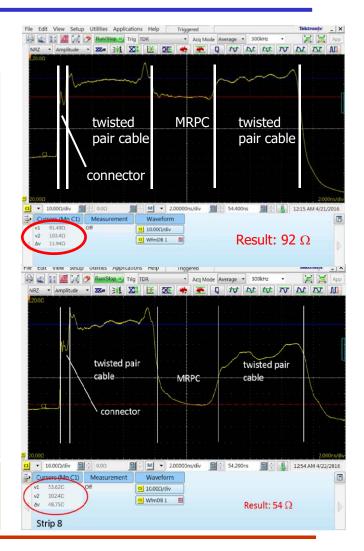


Impedance matching



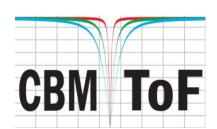
MRPC impedance is LOW!

- Unmatched impedance leads to reflections which is not acceptable for the triggerless CBM DAQ.
- FEE input impedance: ~100 Ω
- Increase MRPC impedance by:
 - ✓ Thinner strip width: 7 mm + 3 mm
 - ✓ Larger distance between opposite strips
- Single- & double-stack MRPC were built and tested.
- Impedance $\sim 100 \Omega$ and 50Ω achieved.
- Double-stack chosen for MRPC3b due to the less HV needed.

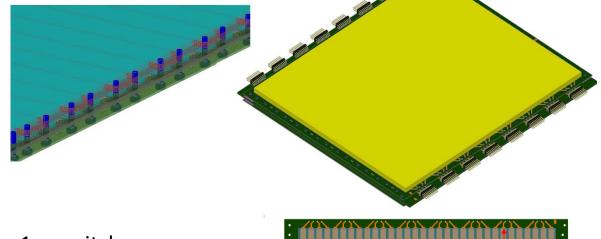


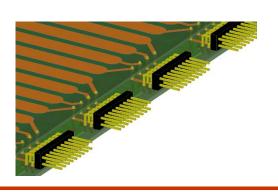


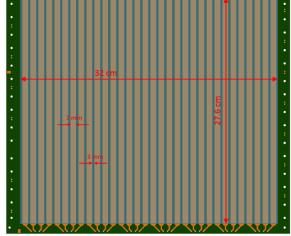
MRPC3b – design



- Thin float glass electrodes
 - 0.28 mm
- Double stacks
 - 230 $\mu m \times 5 \times 2$
- Impedance matching
 - -50Ω
- Double-end strip readout
 - 7 mm strip + 3 mm gap = 1 cm pitch
- Differential signals
- Active area
 - 32 cm \times 27.6 cm
- Detector size
 - 354 \times 324 \times 22 mm

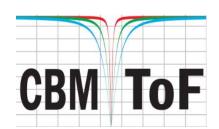




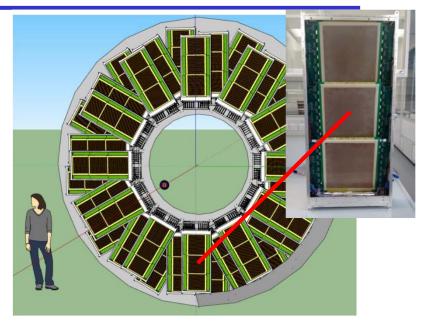


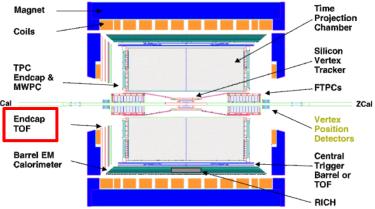


FAIR Phase-0 @ STAR eTOF



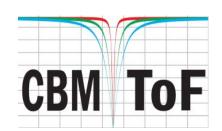
- 120 MRPC3a/b will be installed @ STAR as eTOF for runs 2019-2021.
- Extending the PID coverage and physical potential for STAR.
- Systematical test for CBM TOF.
- MRPC3b mass production started
 @ USTC from March 2017 after a readiness review.
- Production procedures and QC&QA methods established.





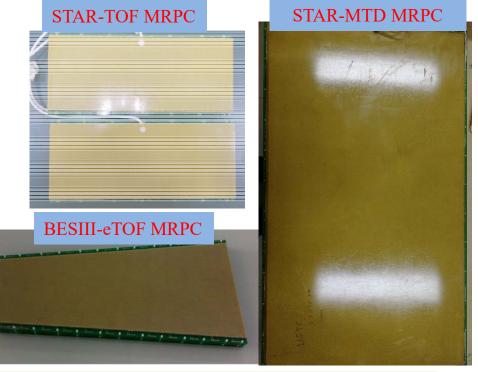


Mass production at USTC



 USTC has the production experience from STAR TOF, STAR MTD, BESIII ETOF, etc.

 More than 1350 / 46 m² MRPC have been produced.



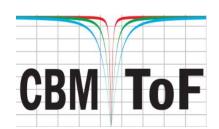
• STAR-TOF $\frac{1210}{1210}$ MRPC production(1/3). Time resolution < 80 ps

• STAR-MTD 59 MRPC production(1/2). System time resolution~120 ps Position resolution~1 cm

• BESIII-eTOF 80 MRPC production(100%). System time resolution~60 ps



QC process



Material check

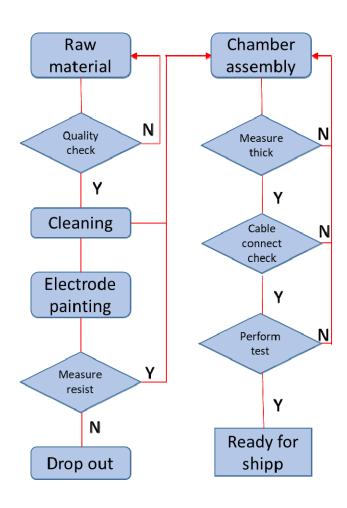
- Honeycomb board, PCB, Kapton foil, glass, fishing line, ...
- Flatness, dimensions, surface quality, resistivity, ...

Process check

 Cleanness, electrical connections, thickness, dimension, gas gap ...

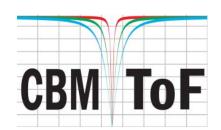
Performance check

 Gas conditioning, HV training, dark current, noise rate, efficiency, time resolution, ...



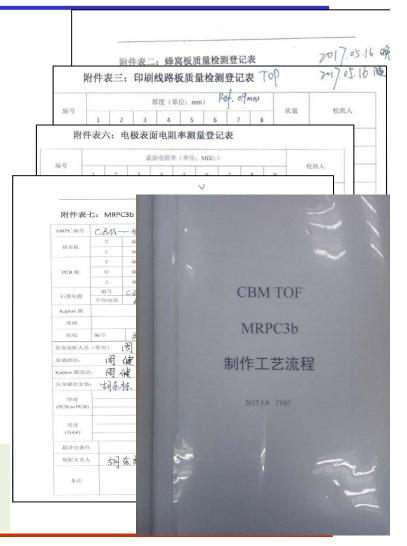


Documentations



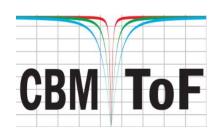
- MRPC3b production process MANUAL
- ➤ 21 assembly steps → Assembly CARDs
- ➤ Flowchart of QC → Check CARDs
- > 7 Record TABLES
 - Material should be checked, labeled, measured, recorded and signed.
 - Each assembly step should be recorded and signed.
 - The performance check results will also be recorded.
- > The records will be input to the data base.

Every counter can be traced back to the raw material and operators.



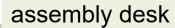


Equipment

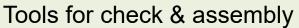






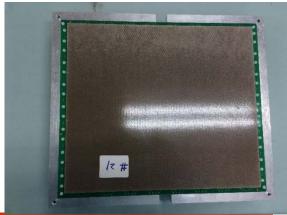






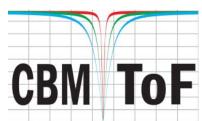




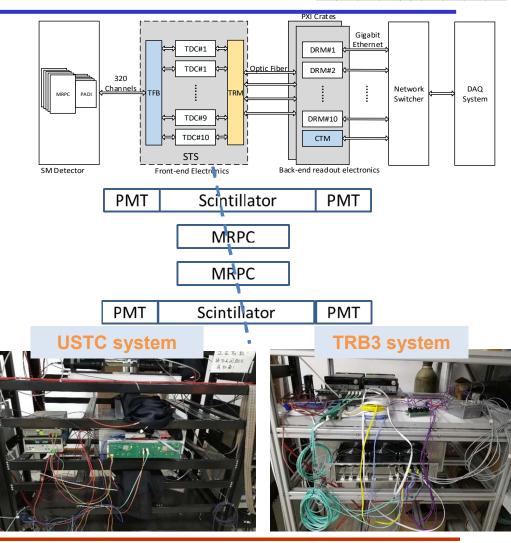




Performance check

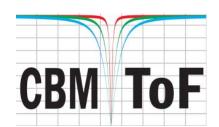


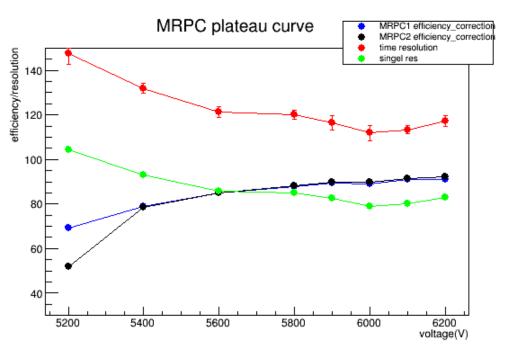
- Cosmic ray test to qualify the produced counters.
- A FPGA-based TDC and DAQ system have been setup by USTC electronics group and token data.
- Another TRB3 TDC and DAQ system is under installation.
- 4 + 4 counters test capability.
- Leak current, noise rate, efficiency, cluster size will be test for all counters.
- Time resolution tested for 1/5 counters.

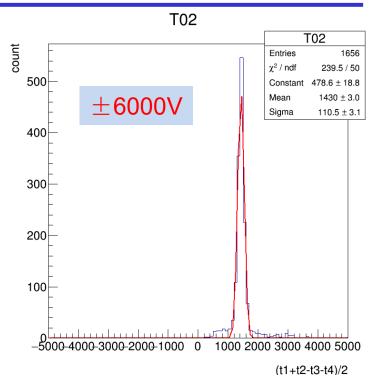




Preliminary results



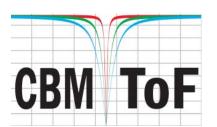




- ullet Set \pm 6000V as the work voltage.
- Efficiency better than 91%.
- System time resolution ~110ps
- Single MRPC time resolution ~78ps.



Statues & Time line

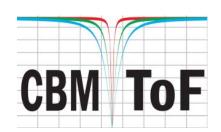


2018	J	F	М	Α	М	J	J	Α	S	0	N	D	J
R&D													
Counter component production													
Counter assembly		5	15	15	15	15	15						
Quality assurance		5	15	15	15	15	15						
MRPC shipment			20	15	15	15	15						

- 6 counters produced for 1st sector installation in Jan. 2018
- 80+ counters to be finished by the fall 2018 for STAR eTOF.
- Ensure the good and uniform quality & performance.



Summary



- MRPC3b, for the low rate region of CBM, has been investigated \rightarrow Thin float glass as electrode and 50 Ω impedance achieved for the preferred double-stack structure.
- The design fixed for the mass production of STAR eTOF.
- The assembly procedures and QA&QC methods have been established.
- After the pre-mass production, 80 counters will be finished by the fall 2018.